DECLARA	TION FOR	TENT	ADDI	ICATION
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**Docket Number Optional)** 

		- contract of optionally
As a below named inventor, 1	I hereby declare that:	MR1035-777
	•	tated below next to my name.
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names are listed below) of the cut	sole inventor (if only one name is	listed below) or an original, first and joint inventor (if plural for which a patent is sought on the invention entitled
SMADT AITTOMATTC DECODE		DESCRIPTION THOU TABLET DESCRIPTION ENTITIES
, the specification of which is attac	hed hereto unless the following	O FOR MONITORING WAFER FRAGMENTATION
		tes Application Number or PCT International Application
Number	and was amer	
		the above identified specification, including the claims, as
amended by any amendment refe I acknowledge the duty to disclose I hereby claim foreign priority beneficertificate, or § 365(a) of any PCT Int	erred to above. information which is material to pati ts under 35 U.S.C. § 119(a)-(d) or t temational application which designa w. by checking the box, any foreign	entability as defined in 37 CFR §1.56. § 365(b) of any foreign application(s) for patent or inventor's atted at least one country other than the United States, listed application for patent or inventor's certificate or PCT
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(Number)	(Country)	(Day/Month/Year Filed)
(Number)	(Country)	(Day (March 07 - 1511 - D
	(Country) U.S.C § 11 9(e) of any United State	(Day/Month/Year Filed) es provisional application(s) listed below.
(Application Number)	(Filing Da	te)
(Application Number)	(Filing Dat	te)
between the filing date of the prior ap	oplication and the national or PCT I	ability as defined in 37 CFR § 1.56 which became available International filing date of this application.
Application Number)	(Filing Date)	(Status-patented, pending, abandoned)
Application Number)	(Filing Date)	(Status-patented, pending, abandoned)
hereby appoint the following attorned	ey(s) and/or agent(s) to prosecute t	his application and to transact all husiness in the Patent and
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elief are believed to be true., and fui	ther that these statements were m mprisonment, or both, under Section	e are true and that all statements made on information and hade with the knowledge that willful false statements and the 1001 of Title 18 of the United States Code and that such atent issued thereon.
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